Quad Exclusive OR Gate

The MC10113 is a quad Exclusive OR gate, with an enable common to all four gates. The outputs may be wire—ORed together to perform a 4-bit comparison function (A = B). The enable is active low.

- $P_D = 175 \text{ mW typ/pkg (No Load)}$
- $t_{pd} = 2.5 \text{ ns typ}$
- t_r , $t_f = 2.0$ ns typ (20%–80%)

LOGIC DIAGRAM Ē V_{CC1} = PIN 1 V_{CC2} = PIN 16 VFF = PIN 8 DIP **PIN ASSIGNMENT** - 15 V_{CC1} V_{CC2} A_{OUT} 15 DOUT BOUT 14 COUT AIN 4 13 DIN5 12 D_{IN} AIN 11 B_{IN} 6 C_{IN} 10 7 C_{IN} B_{IN} ENABLE 9 V_{EE} 8

Pin assignment is for Dual–in–Line Package.
For PLCC pin assignment, see the Pin Conversion Tables on page 18 of the ON Semiconductor MECL Data Book (DL122/D).

TRUTH TABLE

IN		Ē	OUTPUT
L	L	L	L
L	Н	L	Н
Н	L	L	Н
Н	Н	L	L
Х	Χ	Н	L



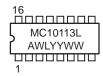
ON Semiconductor

http://onsemi.com

MARKING DIAGRAMS

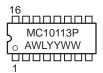


CDIP-16 L SUFFIX CASE 620





PDIP-16 P SUFFIX CASE 648





PLCC-20 FN SUFFIX CASE 775



A = Assembly Location

WL = Wafer Lot YY = Year

WW = Work Week

ORDERING INFORMATION

Device	Package	Shipping		
MC10113L	CDIP-16	25 Units / Rail		
MC10113P	PDIP-16	25 Units / Rail		
MC10113FN	PLCC-20	46 Units / Rail		

ELECTRICAL CHARACTERISTICS

		Test Limits								
		Pin Under	−30°C		+25°C		+85°C		1	
Characteristic	Symbol	Test	Min	Max	Min	Тур	Max	Min	Max	Unit
Power Supply Drain Current	ΙE	8		46			42		46	mAdc
Input Current	l _{in} H	4,7,10,13 5,6,11,12 9		425 350 870			265 220 545		265 220 545	μAdc
	l _{inL}	*	0.5		0.5			0.3		μAdc
Output Voltage Logic 1	Voн	2 3 14 15	-1.060 -1.060 -1.060 -1.060	-0.890 -0.890 -0.890 -0.890	-0.960 -0.960 -0.960 -0.960		-0.810 -0.810 -0.810 -0.810	-0.890 -0.890 -0.890 -0.890	-0.700 -0.700 -0.700 -0.700	Vdc
Output Voltage Logic 0	V _{OL}	2 3 14 15	-1.890 -1.890 -1.890 -1.890	-1.675 -1.675 -1.675 -1.675	-1.850 -1.850 -1.850 -1.850		-1.650 -1.650 -1.650 -1.650	-1.825 -1.825 -1.825 -1.825	-1.615 -1.615 -1.615 -1.615	Vdc
Threshold Voltage Logic 1	VOHA	2 3 14 15	-1.080 -1.080 -1.080 -1.080		-0.980 -0.980 -0.980 -0.980			-0.910 -0.910 -0.910 -0.910		Vdc
Threshold Voltage Logic 0	VOLA	2 3 14 15		-1.655 -1.655 -1.655 -1.655			-1.630 -1.630 -1.630 -1.630		-1.595 -1.595 -1.595 -1.595	Vdc
Switching Times (50 Ω Load)					Min	Тур	Max			ns
Propagation Delay	t ₄₊₂₊ t ₄₋₂₋ t ₉₊₂₋ t ₉₋₂₊	2 2 2 2	1.1 1.1 1.3 1.3	4.7 4.7 5.2 5.2	1.3 1.3 1.5 1.5	2.6 2.6 3.4 3.4	4.5 4.5 5.0 5.0	1.3 1.3 1.5 1.5	5.0 5.0 5.5 5.5	
Rise Time (20 to 80%)	t ₂₊	2	1.1	4.2	1.1	2.5	3.9	1.1	4.4	
Fall Time (20 to 80%)	t ₂ _	2	1.1	4.2	1.1	2.5	3.9	1.1	4.4	

^{*} Individually test each input applying V_{IH} or V_{IL} to input under test.

ELECTRICAL CHARACTERISTICS (continued)

					TEST V	OLTAGE VAI	_UES (Volts)		
		@ Test Te	mperature	V _{IHmax}	V _{ILmin}	VIHAmin	V _{ILAmax}	VEE	
			-30°C	-0.890	-1.890	-1.205	-1.500	-5.2	
			+25°C	-0.810	-1.850	-1.105	-1.475	-5.2	
			+85°C	-0.700	-1.825	-1.035	-1.440	-5.2	
Pin		TEST VOLTAGE APPLIED TO PINS LISTED BELOW							
Characteristic		Symbol	Under Test	V _{IHmax}	V _{ILmin}	V _{IHAmin}	V _{ILAmax}	VEE	(V _{CC}) Gnd
Power Supply Drain C	Current	ΙΕ	8					8	1, 16
Input Current		linH	4,7,10,13 5,6,11,12 9	* * 9				8 8 8	1, 16 1, 16 1, 16
		l _{inL}	*		*			8	1, 16
Output Voltage	Logic 1	VOH	2 3 14 15	4 7 11 13				8 8 8 8	1, 16 1, 16 1, 16 1, 16
Output Voltage	Logic 0	VOL	2 3 14 15		4 7 11 13			8 8 8 8	1, 16 1, 16 1, 16 1, 16
Threshold Voltage	Logic 1	VOHA	2 3 14 15			4 6 10 12		8 8 8 8	1, 16 1, 16 1, 16 1, 16
Threshold Voltage	Logic 0	VOLA	2 3 14 15				5 7 11 13	8 8 8	1, 16 1, 16 1, 16 1, 16
Switching Times	(50Ω Load)			+1.11V		Pulse In	Pulse Out	-3.2 V	+2.0 V
Propagation Delay		t ₄₊₂₊ t ₄₋₂₋ t ₉₊₂₋ t ₉₋₂₊	2 2 2 2	4 4		4 4 9 9	2 2 2 2	8 8 8	1, 16 1, 16 1, 16 1, 16
Rise Time	(20 to 80%)	t ₂₊	2			4	2	8	1, 16
Fall Time	(20 to 80%)	t ₂ _	2			4	2	8	1, 16

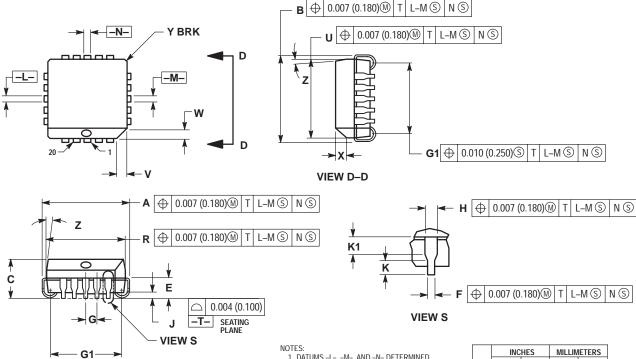
^{*} Individually test each input applying V_{IH} or V_{IL} to input under test.

Each MECL 10,000 series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained. Outputs are terminated through a 50-ohm resistor to -2.0 volts. Test procedures are shown for only one gate. The other gates are tested in the same manner.

PACKAGE DIMENSIONS

PLCC-20 **FN SUFFIX**

PLASTIC PLCC PACKAGE CASE 775-02 ISSUE C



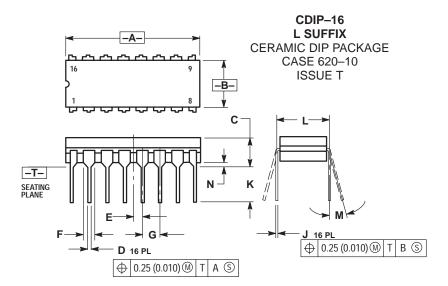
⊕ 0.010 (0.250)⑤ T L-M ⑤ N ⑤

- DATUMS -L-, -M-, AND -N- DETERMINED
 WHERE TOP OF LEAD SHOULDER EXITS PLASTIC WILLY LOVE LEAD STOUDER EXTENSIVE SOLUTION TO BE MEASURED AT DATUM -T-, SEATING PLANE.

 3. DIMENSIONS R AND U DO NOT INCLUDE MOLD
- FLASH. ALLOWABLE MOLD FLASH IS 0.010 (0.250) PER SIDE.
 4. DIMENSIONING AND TOLERANCING PER ANSI
- Y14.5M, 1982. 5. CONTROLLING DIMENSION: INCH.
- 6. THE PACKAGE TOP MAY BE SMALLER THAN THE PACKAGE BOTTOM BY UP TO 0.012 (0.300). DIMENSIONS R AND U ARE DETERMINED AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY EXCLUSIVE OF MOLD FLASH, TIE BAR BURRS, GATE BURRS AND INTERLEAD FLASH, BUT INCLUDING ANY MISMATCH BETWEEN THE TOP AND BOTTOM OF THE PLASTIC BODY.
- DIMENSION H DOES NOT INCLUDE DAMBAR PROTRUSION OR INTRUSION. THE DAMBAR PROTRUSION(S) SHALL NOT CAUSE THE H DIMENSION TO BE GREATER THAN 0.037 (0.940). THE DAMBAR INTRUSION(S) SHALL NOT CAUSE THE H DIMENSION TO BE SMALLER THAN 0.025 (0.635).

	INC	HES	MILLIN	IETERS
DIM	MIN	MAX	MIN	MAX
Α	0.385	0.395	9.78	10.03
В	0.385	0.395	9.78	10.03
С	0.165	0.180	4.20	4.57
Ε	0.090	0.110	2.29	2.79
F	0.013	0.019	0.33	0.48
G	0.050	BSC	1.27	BSC
Н	0.026	0.032	0.66	0.81
J	0.020		0.51	
K	0.025		0.64	
R	0.350	0.356	8.89	9.04
U	0.350	0.356	8.89	9.04
٧	0.042	0.048	1.07	1.21
W	0.042	0.048	1.07	1.21
Χ	0.042	0.056	1.07	1.42
Υ		0.020		0.50
Z	2°	10 °	2 °	10 °
G1	0.310	0.330	7.88	8.38
K1	0.040		1.02	

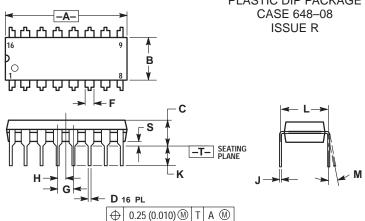
PACKAGE DIMENSIONS



- NOTES:
 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: INCH.
 3. DIMENSION L TO CENTER OF LEAD WHEN FORMED PARALLEL.
 4. DIMENSION F MAY NARROW TO 0.76 (0.030) WHERE THE LEAD ENTERS THE CERAMIC BODY.

	INC	HES	MILLIMETERS		
DIM	MIN MAX		MIN	MAX	
Α	0.750	0.785	19.05	19.93	
В	0.240	0.295	6.10	7.49	
С		0.200		5.08	
D	0.015	0.020	0.39	0.50	
E	0.050) BSC	1.27 BSC		
F	0.055	0.065	1.40	1.65	
G	0.100	BSC	2.54 BSC		
Н	0.008	0.015	0.21	0.38	
K	0.125	0.170	3.18	4.31	
L	0.300	BSC	7.62	BSC	
M	0°	15°	0 °	15°	
N	0.020	0.040	0.51	1.01	

PDIP-16 **P SUFFIX** PLASTIC DIP PACKAGE



- NOTES:
 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: INCH.
 3. DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL.
 4. DIMENSION B DOES NOT INCLUDE MOLD FLASH.
 5. ROUNDED CORNERS OPTIONAL.

	INC	HES	MILLIN	IETERS	
DIM	MIN MAX		MIN	MAX	
Α	0.740	0.770	18.80	19.55	
В	0.250	0.270	6.35	6.85	
С	0.145	0.175	3.69	4.44	
D	0.015	0.021	0.39	0.53	
F	0.040	0.70	1.02	1.77	
G	0.100	BSC	2.54 BSC		
Н	0.050	BSC	1.27 BSC		
J	0.008	0.015	0.21	0.38	
K	0.110	0.130	2.80	3.30	
L	0.295	0.305	7.50	7.74	
M	0°	10 °	0 °	10 °	
S	0.020	0.040	0.51	1.01	

Notes

Notes

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